
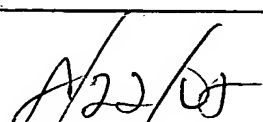


FORM PTO-1449 (Modified)			Attorney Docket No.: 20843-00010US		Application No. Unassigned	
LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT (Use several sheets if necessary)			Applicant: JESUS AL ORTIZ et al.			
			Filing Date: Herewith		Group: Unassigned	
Reference Designation			U.S. PATENT DOCUMENTS			Page 1
Examiner Initial	Document No.	Date	Name	Class	Sub-class	Filing Date (If Appropriate)
AA	3,469,016	09/1969	Shelton			
AB	3,639,674	02/1972	Stier			
AC	3,744,128	07/1973	Fisher et al.			
AD	4,106,839	08/1978	Cooper			
AE	4,209,215	06/1980	Verma			
AF	4,234,759	11/1980	Harlow			
AG	4,236,779	12/1980	Tang			
AH	4,433,206	02/1984	Lewis			
AI	4,457,576	07/1984	Cosmos et al.			
AJ	4,475,006	10/1984	Olyphant, Jr.			
AK	4,721,483	01/1988	Dickie			
AL	4,489,116	12/1984	Flood			
AM	4,497,533	02/1985	Genova et al.			
AN	4,508,414	04/1985	Kusui et al.			
AO	4,515,993	05/1985	MacKenzie			
AP	4,542,076	09/1985	Bednarz et al.			
AQ	4,564,723	01/1986	Lang			
AR	4,597,624	07/1986	Lax et al.			
AS	4,714,905	12/1987	Bernstein et al.			
AT	4,721,483	01/1988	Dickie			
AU	4,748,293	05/1988	Kikuchi et al.			
AV	4,842,553	06/1989	Ingram			
AW	4,845,311	07/1989	Schreiber et al.			
AX	4,846,724	07/1989	Sasaki et al.			
AY	4,933,060	06/1990	Prohaska et al.			
AZ	4,972,041	11/1990	Crawley et al.			
BA	4,973,514	11/1990	Gamble et al.			
BB	4,983,452	01/1991	Daimon et al.			
BC	4,988,550	01/1991	Keyser et al.			
BD	5,003,126	03/1991	Fujii et al.			
BE	5,008,487	04/1991	Shimmyo			
BF	5,017,419	05/1991	Smith			
BG	5,028,490	07/1991	Koskenmaki et al.			
BH	5,047,260	09/1001	Durand			
BI	5,071,519	12/1991	Ferrill et al.			

FORM PTO-1449 (Modified)			Attorney Docket No.: 20843-00010US		Application No. Unassigned	
LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT (Use several sheets if necessary)			Applicant: JESUS AL ORTIZ et al.		Group: Unassigned	
			Filing Date: Herewith			
BJ	5,170,009	12/1992	Kadokura			
BK	5,180,639	01/1993	Zarnoch			
BL	5,191,544	03/1993	Benck et al.			
BM	5,206,796	04/1993	Thompson et al.			
BN	5,214,242	05/1993	Gallagher			
BO	5,225,629	07/1993	Garrett			
BP	5,226,210	07/1993	Koskenmaki et al.			
BQ	5,235,492	08/93	Humbert et al.			
BR	5,250,342	10/1993	Lang et al.			
BS	5,270,488	12/1993	Ono et al.			
BT	5,281,762	01/1994	Long et al.			
BU	5,405,000	04/1995	Hagedon et al.			
BV	5,436,803	07/1995	Annis et al.			
BW	5,455,383	10/1995	Tanaka			
BX	5,483,020	01/1996	Hardie et al.			
BY	5,559,677	09/1996	Errichiello			
BZ	5,571,992	11/1996	Maleski et al.			
CA	5,574,815	11/1996	Kneeland			
CB	5,811,050	09/1998	Gabower			
CC	5,829,991	11/1998	Murphy et al.			
CD	5,885,710	03/1999	MacDonald, Jr. et al.			
CE	5,967,855	10/1999	Asakura et al.			
CF	6,036,539	03/2000	Rigby et al.			
CG	6,047,660	04/2000	Lee			
CH	6,080,018	06/2000	Ferrill et al.			
CI	6,109,969	08/2000	Kuo et al.			
CJ	6,123,556	09/2000	Asakura et al.			
CK	6,127,038	10/2000	McCullough et al.			
FOREIGN PATENT DOCUMENTS						
	Document No.	Date	Country	Class	Sub-class	Translation (Yes/No)
OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)						
CL	Adams; <i>Taking the Mystery Out of Metallizing</i> , Vacuum Technology (November 1975) Technical Publishing Company, 4 pages total.					
CM	Adams; <i>Taking the Mystery Out of Metallizing-II</i> , Vacuum Technology (December 1975) Technical Publishing Company, 3 pages total.					
CN	Adams; <i>Taking the Mystery Out of Metallizing-III</i> , Vacuum Technology (February 1976) Technical Publishing Company, 4 pages total.					
CO	Gabower, <i>Thermoformed Vacuum-Metallized Inserts For EMI Shielding</i> , ITEM (1995) The International Journal of EMC, Robar Industries, Inc., pp. 120, 122, 123, and 127.					

FORM PTO-1449 (Modified)		Attorney Docket No.: 20843-00010US	Application No. Unassigned
LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT (Use several sheets if necessary)		Applicant: JESUS AL ORTIZ et al.	
		Filing Date: Herewith	Group: Unassigned
<input checked="" type="checkbox"/> CP	Gabower, <i>Thermoformed Vacuum Metallized Inserts For EMI Shielding of Electronic Devices</i> , Consumer Electronics Show, Flamingo Hilton and Tower, Las Vegas, Nevada, pp. 151-158.		
<input checked="" type="checkbox"/> CO	Gwinner, <i>Vacuum Evaporated Aluminum for Selective Shielding of Plastic Housings</i> , ITEM (1993) The International Journal of EMC, Robar Industries, Inc., pp. 138, 140, 290, 292, 294, and 296.		
<input checked="" type="checkbox"/> CR	Hasler, <i>Electroplating and Vacuum Metalizing</i> , Galvanotechnic (1984) Volume 2, 5 pages total.		
<input checked="" type="checkbox"/> CS	Kimmel et al., <i>Shielding for EMI control...and how to do it right</i> , EDN (January 20, 1994) pp. S59-S69.		
<input checked="" type="checkbox"/> CT	Leonard, <i>What's Hot and What's Not in EMI Shielding of Plastics</i> , Plastics Design Forum (March/April 1993) pp. 32-35.		
<input checked="" type="checkbox"/> CU	Smock, <i>Trend to Lower Cost Resins Will Accelerate</i> , Plastics World (April 1995) 1 page total.		
<input checked="" type="checkbox"/> CV	Rigney, <i>Vacuum Coating</i> , pp. 387-388, 390-410.		
<input checked="" type="checkbox"/> CW	Chomerics, Inc., <i>EMI Shielding for Commercial Electronics</i> (1994) pp. 4-5, 30-33.		
<input checked="" type="checkbox"/> CX	Concise Encyclopedia of Polymer Science & Engineering, John Wiley & Sons, (1990) ISBN 0-471-51253-2, pp. 446-746, 1192-1195.		
<input checked="" type="checkbox"/> CY	Holland, <i>Degassing of Plastic Materials/Plasticizers</i> , Vacuum Deposition of Thin Films, Chapman & Hall Ltd., London (1966) pp. 46-47, 52-53.		
<input checked="" type="checkbox"/> CZ	EMI Protection in Consumer Portable Products, Electronic Packaging and Production (March 1994) pp. 40-44.		
<input checked="" type="checkbox"/> DA	Grgg et al., <i>Machinery's Handbook</i> , Industrial Press, New York (1976) pp. 2299-2301.		
<input checked="" type="checkbox"/> DB	EMI/REI Shielding Guide, General Electric Plastics Co. pp. 1-50.		
<input checked="" type="checkbox"/> DC	Vacuum Metallizing Electrical Problems, TIPS, Midwest Tungsten Service (1986) 2 pages total.		
<input checked="" type="checkbox"/> DD	6100 Thermoformable EMI-Shielding Material, Minnesota Mining & Mfg. Co. (1994) 2 pages total.		
<input checked="" type="checkbox"/> DE	Orion® Designs Economical EMI Shielding Box Without Cutting Corners, Product Brochure, Orion® Industries Incorporated, 1 page total.		
<input checked="" type="checkbox"/> DF	New Solutions for the Electronic Age, Placon Corp., Madison, Wisconsin, Sales Brochure; 1 page total.		
<input checked="" type="checkbox"/> DG	Silver-Coated VALOX FR-1 Film Provides Shielding For Circuit Breakers, GE Films in Action (June 1994) General Electric Co., 1 page total.		
<input checked="" type="checkbox"/> DH	Style CBS Circuit Board Component Shielding - Design Guide 4, Product Brochure, Leader Tech., Tampa, Florida, 2 pages total.		
<input checked="" type="checkbox"/> DI	Ultrasonic Welders Advance Clamshell-Sealing Process, Packaging (October 1994) pp. 78-21.		
<input checked="" type="checkbox"/> DJ	Vacuum Platers, Inc. (VPI), Product Brochure, 4 pages total.		
<input checked="" type="checkbox"/> DK	EMI/RFI Products EE-Evaluation Engineering (April 1995) pp. 64.		
<input checked="" type="checkbox"/> DL	Silver Shielding for the Highest Performance, Swift Textile Metalizing Corporation, ITEM (1995) pp. 11, 15, 109, 112, 113, 115, 116, 212, 213, 267, 269.		
<div style="display: flex; justify-content: space-between;"> <div>EXAMINER </div> <div>DATE CONSIDERED </div> </div>			

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.